

## Features

- Ultra-Small Surface Mount Package
- Guard Ring Die Construction for Transient Protection
- High Surge Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: POWERDI323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (1)
- Weight: 0.006 grams (approximate)

#### POWERDI323





### Ordering Information (Note 4)

Part Number	Case	Packaging
PD3S140-7	POWERDI323	3000/Tape & Reel
PD3S140Q-7	POWERDI323	3000/Tape & Reel

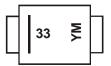
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



33 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: U = 2006) M = Month (ex: 9 = September)

Date	Code	Key	

Year	2006	2007	2008	2009	2010	2011	2012	201	3	2014	2015	2016	2017	2018
Code	Т	U	V	W	Х	Y	Z	A		В	С	D	E	F
Month	Jan	Feb	Mar	Apr	Ma	y J	un	Jul	Au	g	Sep	Oct	Nov	Dec
Code	1	2	3	4	5		6	7	8		9	0	Ν	D



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.			
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> Vrwm Vr	40	V
Average Forward Current (See also figure 4)	I <sub>F(AV)</sub>	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	22	A

### **Thermal Characteristics**

Notes:

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	R <sub>0</sub> JS	—	15	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta JA}$	175	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ heta JA}$	130	—	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to	+150	°C

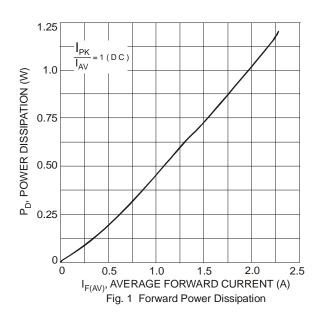
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

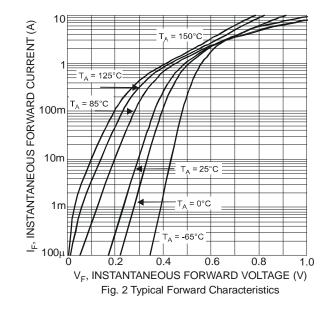
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	40		_	V	I <sub>R</sub> = 100μA
		_	0.37	0.42		$I_{F} = 0.1A$
		_	0.44	0.50	V	I <sub>F</sub> = 0.5A
Forward Voltage	VF	_	0.46	0.52		I <sub>F</sub> = 0.7A
		_	0.49	0.55		$I_{F} = 1.0A$
Lackage Current (Note 7)		_	0.3	4		V <sub>R</sub> = 5V, T <sub>A</sub> = +25°C
Leakage Current (Note 7)	IR	_	2	50	μA	V <sub>R</sub> = 40V, T <sub>A</sub> = +25°C
Total Capacitance (See also figure 3)	CT	_	32	_	pF	V <sub>R</sub> = 10V, f = 1.0MHz

5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.  $T_A = +25^{\circ}C$ .

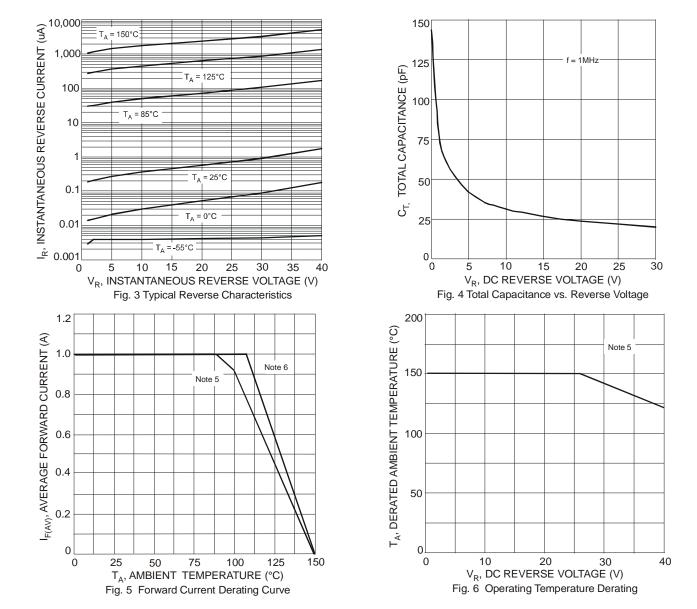
6. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.  $T_A = +25^{\circ}C$ .

7. Short duration pulse test used to minimize self-heating effect.



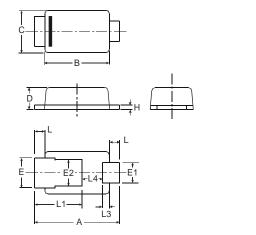






## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



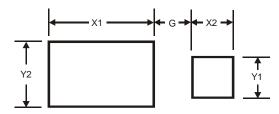
POWERDI323						
Dim	Min	Max	Тур			
Α	2.40	2.60	2.50			
В	1.85	1.95	1.90			
С	1.20	1.30	1.25			
D	0.60	0.70	0.65			
Е	0.78	0.98	0.88			
E1	0.50	0.70	0.60			
E2	0.60	1.00	0.80			
Н	0.08	0.18	0.13			
L	0.20	0.40	0.30			
L1		_	1.40			
L3	—	_	0.20			
L4	0.40	0.80	0.60			
All D	Dimens	sions in	mm			

POWERDI is a registered trademark of Diodes Incorporated. PD3S140 Document number: DS30862 Rev. 12 - 2



# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	0.5
X1	2.0
X2	0.8
Y1	0.8
Y2	1.1

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